



Edgetek™ ET9700-5015 X1 BLACK

Polyphthalamide

Key Characteristics

Product Description

The Edgetek® Engineering Thermoplastic Compounds portfolio covers a broad range of standard and custom-formulated high performance materials. This portfolio includes high-temperature materials for elevated service temperature environments, high reflectivity, high-modulus / structural materials for load-bearing and high-strength applications and flame-retardant products. These compounds are based on selected engineering thermoplastic resins which are compounded with reinforcing additives such as glass fiber and mineral fillers.

General

Material Status	• Commercial: Active
Regional Availability	• Africa & Middle East • Europe
Filler / Reinforcement	• Glass Fiber
Features	• High Heat Resistance • Light Stabilized
Uses	• Consumer Applications • General Purpose • Electrical/Electronic Applications • Industrial Applications
Forms	• Pellets
Processing Method	• Injection Molding

Technical Properties ¹

Physical	Typical Value (English)	Typical Value (SI)	Test Method
Density	1.57 g/cm ³	1.57 g/cm ³	ISO 1183
Mechanical	Typical Value (English)	Typical Value (SI)	Test Method
Tensile Modulus	2.45E+6 psi	16900 MPa	ISO 527-2
Tensile Stress	35500 psi	245 MPa	ISO 527-2
Tensile Strain (Break)	2.5 %	2.5 %	ISO 527-2
Flexural Modulus	1.84E+6 psi	12700 MPa	ISO 178
Flexural Stress	47100 psi	325 MPa	ISO 178
Impact	Typical Value (English)	Typical Value (SI)	Test Method
Charpy Notched Impact Strength	4.8 ft·lb/in ²	10 kJ/m ²	ISO 179
Charpy Unnotched Impact Strength	36 ft·lb/in ²	75 kJ/m ²	ISO 179
Thermal	Typical Value (English)	Typical Value (SI)	Test Method
Heat Deflection Temperature 264 psi (1.8 MPa), Unannealed	446 °F	230 °C	ISO 75-2/A

Processing Information

Injection	Typical Value (English)	Typical Value (SI)
Drying Temperature	194 to 248 °F	90 to 120 °C
Drying Time	2.0 to 4.0 hr	2.0 to 4.0 hr
Processing (Melt) Temp	572 to 626 °F	300 to 330 °C
Mold Temperature	212 to 284 °F	100 to 140 °C

Notes

¹ Typical values are not to be construed as specifications.